

## Thyristor – Diode Module

### Features

- Improved glass passivation for high reliability
- Exceptional stability at high temperatures
- High di/dt and dv/dt capabilities
- Low thermal resistance

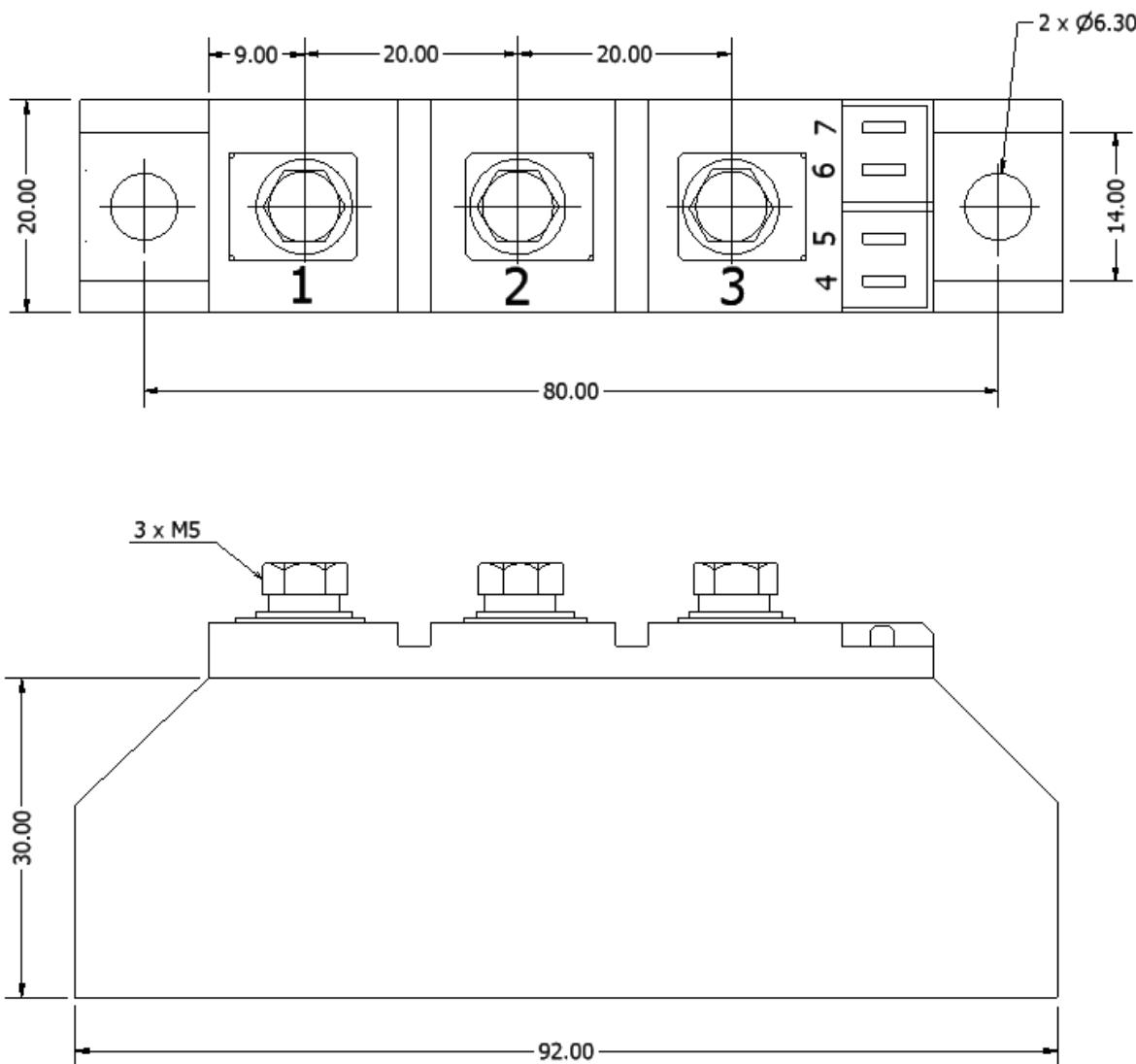
Maximum Ratings ( $T_A = 25^{\circ}\text{C}$ unless otherwise noted)			
Parameter	Symbol	Values	Units
Maximum average forward current @ $T_J = 85^{\circ}\text{C}$	$I_{F(\text{AV})}$	56	A
Maximum average RMS forward current	$I_{F(\text{RMS})}$	130	A
Maximum non-repetitive surge current @ $t = 10\text{ms}$	$I_{\text{FSM}}$	1300	A
Maximum $I^2t$ for fusing @ $t = 10\text{ms}$	$I^2t$	8000	$\text{A}^2\text{s}$



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Thermal & Mechanical Specifications ( $T_A = 25^{\circ}\text{C}$ unless otherwise noted)			
Parameter	Symbol	Values	Units
Operating junction temperature range	$T_J$	-65 to +125	$^{\circ}\text{C}$
Thermal resistance, junction to case	$R_{\text{th}(\text{JC})}$	0.55	$^{\circ}\text{C}/\text{W}$

Electrical Characteristics ( $T_A = 25^{\circ}\text{C}$ unless otherwise noted)			
Parameter	Symbol	Values	Units
Maximum average on-state current	$I_{T(\text{max})}$	56	A
Maximum repetitive peak reverse voltage range	$V_{\text{RRM}}$	200 to 1600	V
Forward voltage drop	$V_{\text{FM}}$	1.2	V
Gate current required to trigger	$I_{\text{GT}}$	100	A
Gate voltage required to trigger	$V_{\text{GT}}$	2	V
Holding current range	$I_H$	5 to 100	mA
Maximum latching current	$I_L$	400	mA
Critical rate of rise of off-state voltage	$dv/dt$	300	$\text{V}/\mu\text{s}$
RMS isolated voltage	$V_{\text{ISO}}$	2500	V



ALL DIMENSIONS ARE IN MM

### Diode Configuration

